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Table of Contents

Volume 8 Number 4

November 2017

**Research on the Construction of Intellectual Property Operation Platform under the
Background of “Internet +”**

J. L. Yin, Z. Z. Ge, W. Song.....179

Technology and Investment (TI)

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Technology and Investment (TI) is an international journal dedicated to the latest advancement of technology and investment. The goal of this journal is to provide a platform for doctors and academicians all over the world to promote, share, and discuss various new issues and developments in technology and investment related problems.

Editor-in-Chief

Prof. Willi Semmler

New School University, USA

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